F Fuji Electric 7MBR100XNA120-50

Innovating Energy Technology

IGBT Modules

Power Module(X series) 1200V / 100A / PIM

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□ Feactures □ Typical appearance deed and send seemended Low V_{CE(sat)} **Compact Package** P.C.Board Mount Module Herettrattrattar Converter Diode Bridge Dynamic Brake Circuit **RoHS compliant Product** □Applications Inverter for Motor Drive AC and DC Servo Drive Amplifier Uniterruptible Power Supply 0 □ Outline drawing (Unit : mm) shows theoretical dimension. shows reference dimension. 122 ±1 110 ±0.3 8-R2.25 ±0.3 11.5^{+0.5} 58.81 62.62 66.43 4-ø5.5±0.3 11.5 0.5 2) 22 2 00 54.21 \bigcirc ð 57.5±0.3 50 ±0.3 62±1 99.6± Ð - I I I I 114.055 4.055 14.995 79.765 30.235 15.475 19.285 4.045 38.335 33.575 loi z 94.5±0.3 0.15 **(** Ø0.5 Ø2.25±0.1 5±0.3 nnnn l 000000 NUUU 0000 0 0 00 19°.3 0 HO.3 Indication on module Sction A-A Weight: 310 g (typ.) □ Equivalent circuit [Converter] [Brake] [Inverter] [Thermistor] **000** @0 (P) (P1) (Gu) (Gv) (Gw) Ð Ð Ō 1 1

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For Fuji Electric **7MBR100XNA120-50**

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\Box Maximum ratings (at $T_c = 25^{\circ}C$ unless otherwise specified)

Items Collector-Emitter voltage		Symbols	Is Conditions		Maximum ratings	Units
		V _{CES}			1200	V
Gate-Emitter	voltage	V _{GES}			±20	V
		I _C	Continuous	<i>T</i> _c =100°C	100	
Collector curr	ent	I _c pulse	1ms		200	
-		I _F	Continuous		100	A
Forward curre	ent	I _F pulse	1ms		200	
Collector pow	er dissipation	Pc	1 device		445	W
Collector-Emi	tter voltage	V _{CES}			1200	V
Gate-Emitter	voltage	V _{GES}			±20	V
Collector current		I _C	Continuous	<i>T</i> _c =100°C	75	^
		I _c pulse	1ms		150	A
Collector pow	er dissipation	Pc	1 device		335	W
Forward current		I _F	Continuous		35	
		I _{FRM}	1ms		70	A
T I	ak reverse voltage	V _{RRM}			1200	V
Repetitive pea	ak reverse voltage	V _{RRM}			1600	V
Average outp	ut current : (Non-Repetitive) (*1)	I _o	Three-phase full wave rectified current	^в <i>T_c=80°С</i>	100	A
	(Non Donatitiva) (*1)	I _{FSM}		T _{vj} =25°C	945	^
Surge current			t=10ms, -Half sine wave form	T _{vj} =150°C	775	A
I ² t (Non-Rep		l^2t		T _{vj} =25°C	4485	A ² s
I I (NON-Rep		11		<i>T</i> _{vj} =150°C	3000	AS
lunction tompo	caturo	T _{vj}	Inverter, Brake		175	
Junction temperature		I vj	Converter		150	- °C
Operating junction temperature (under switching conditions)		T_{vjop}	Inverter, Brake		175	
			Converter		150	
Case temperature		T _c			125	
Storage temper	ature	T _{stg}			-40 ~ 125	
Isolation voltage	between terminals and copper base (*2) between thermistor and others (*3)	- V _{iso}	A.C. : 1min.		2500	Vrms
Screw torque (*4)	Mounting	-	M5		6.0	N∙m

(*1) T_{vj} : Temperature at test start.

(*2) All terminals should be connected together during the test.

(*3) Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

(*4) Recommendable value : Mounting $2.5 \sim 6.0 \text{ N} \cdot \text{m}$ (M5)



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\Box Electrical characteristics (at T_{vj} = 25°C unless otherwise specified)

Items	Symbols	Symbols Conditions		Characteristics			Units
nems	Symbols	Conditions		min.	typ.	max.	Units
Zero Gate voltage collector current	/ _{CES}	$V_{GE} = 0V$ $V_{CE} = 1200V$		-	-	50	μA
Gate-Emitter leakage current	I _{GES}	$V_{\rm CE} = 0V$ $V_{\rm GE} = +20/-2$	20V	-	-	100	nA
Gate-Emitter threshold voltage	V _{GE(th)}	$V_{\rm CE} = 20V$ $I_{\rm C} = 100 {\rm mA}$		6.0	6.5	7.0	V
	V _{CE(sat)} (terminal)	V _{GE} = 15V I _C = 100A	T _{vj} =25°C	-	1.70	2.20	
Collector-Emitter			T _{vj} =25°C	-	1.45	1.90	
saturation voltage	V _{CE(sat)}		T _{vj} =125°C	-	1.80	-	V
	(chip)		T _{vi} =150°C	-	1.85	-	-
			T _{vi} =175°C	-	1.90	-	-
Internal Gate resistance	r _g	-	.,	-	5.6	-	Ω
Capacitance	C _{ies}			-	11.6	-	
	C _{oes}	$V_{\rm CE} = 10V, V_{\rm GE} = 0V, f = 2$	1MHz	-	0.40	-	nF
	Cres		-	-	0.10	-	-
Gate charge	Q _G	$V_{\rm CC} = 600 V V_{\rm GE} = -15 \rightarrow -100 A$	+15V	-	740	-	nC
	V _F (terminal) V _F (chip)	/ _F = 100A	T _{vj} =25°C	-	2.05	2.55	
		-	., Τ _{vi} =25°C	-	1.80	2.25	-
Forward voltage			-, Τ _{vi} =125°C	-	1.85	-	V
· ····ai a ····ago			τ _{vi} =150°C	-	1.80	-	1
			τ _{vi} =175°C	-	1.75	-	-
		$V_{\rm CC} = 600 V$	T _{vi} =25°C	-	0.21	-	
	t _{d(on)}	$I_{\rm C}, I_{\rm F} = 100 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	-, Τ _{vi} =125°C	-	0.25	-	-
		V _{GE} = +15/-15 V	., Τ _{vi} =150°C	-	0.25	-	
		$R_{\rm G} = 5.1 \Omega$	τ _{vi} =175°C	-	0.26	-	-
		$V_{\rm CC} = 600 V$	T _{vi} =25°C	-	0.05	-	
		$I_{\rm C}, I_{\rm F} = 100 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	τ _{vi} =125°C	-	0.06	-	-
	t _r	V _{GE} = +15/-15 V	τ _{vj} =150°C	-	0.06	-	-
		$R_{\rm G} = 5.1 \Omega$	τ _{vi} =175°C	-	0.06	-	-
Switching time (*1)		$V_{\rm CC} = 600 V$	T _{vj} =25°C	-	0.29	-	-
		$I_{\rm C}, I_{\rm F} = 100 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	vj=125°C	-	0.32	-	-
	$t_{d(off)}$	$V_{\rm GE} = +15/-15 \rm V$	T _{vi} =150°C	_	0.33	-	μs
		$R_{\rm G} = 5.1 \Omega$	T _{vj} =175°C	-	0.34	-	-
		$V_{\rm CC} = 600 V$	$T_{\rm vi}=25^{\circ}\rm C$	-	0.10	-	1
		$I_{\rm C}, I_{\rm F} = 100 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	$T_{vj}=125^{\circ}C$	-	0.16	-	-
	t _f	$V_{GE} = +15/-15 V$	$T_{vj} = 120^{\circ} C$ $T_{vi} = 150^{\circ} C$	-	0.10	-	+
		$R_{\rm G} = 5.1 \Omega$	T _{vi} =175°C	-	0.10	-	+
		$V_{\rm CC} = 600 V$	$T_{vj}=175$ C	-	0.20	-	-
		$l_{\rm C}, l_{\rm F} = 100 L_{\rm s} = 30 $	$T_{vj}=25^{\circ}C$ $T_{vi}=125^{\circ}C$	-	0.11	-	ł
Reverse recovery time	t _{rr}	$V_{\rm GE} = +15/-15 \rm V$	$T_{vj}=125$ C $T_{vi}=150$ °C	-	0.18	_	ł
			1 vi-100 C	-	0.22	-	1

(*1) Turn on time $(t_{on}) = t_{d(on)} + t_r$, Turn off time $(t_{off}) = t_{d(off)} + t_f$

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Itomo	Symbolo	Conditions		Characteristics			Unit
Items	Symbols	Conditions	-	min.	typ.	max.	Unit
		$V_{\rm CC} = 600 {\rm V}$	T _{vj} =25°C	-	7.45	-	
	E _{on}	$I_{\rm C}, I_{\rm F} = 100 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	<i>T</i> _{vj} =125°C	-	10.51	-	
	- on	$V_{\rm GE}$ = +15/-15 V	T _{vj} =150°C	-	11.50	-	
		$R_{\rm G} = 5.1 \Omega$	<i>T</i> _{νj} =175°C	-	12.79	-	
		$V_{\rm CC} = 600 \rm V$	T _{vj} =25°C	-	7.07	-	
Switching loss	$E_{\rm off}$	$I_{\rm C}, I_{\rm F} = 100 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	<i>T</i> _{vj} =125°C	-	8.82	-	mJ
(per pulse)	- off	V _{GE} = +15/-15 V	T _{vj} =150°C	-	9.55	-	IIIJ
		$R_{\rm G} = 5.1 \Omega$	<i>T</i> _{νj} =175°C	-	9.93	-	
		$V_{\rm CC} = 600 \rm V$	T _{vj} =25°C	-	3.00	-	
	Err	$I_{\rm C}, I_{\rm F} = 100 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	<i>T</i> _{vj} =125°C	-	4.88	-	1
	L m	$V_{\rm GE}$ = +15/-15 V	<i>T</i> _{vj} =150°C	-	5.88	-	1
		$R_{\rm G} = 5.1 \Omega$	T _{vj} =175°C	-	6.51	-	
Zero Gate voltage	I _{CES}	$V_{\rm GE} = 0 \rm V$		-	-	50	μA
collector current		V _{CE} = 1200V					
Gate-Emitter leakage current	I _{GES}	$V_{\rm CE} = 0V, V_{\rm GE} = +20/-2$	20V	-	-	100	nA
	V _{CE(sat)} (terminal)	$V_{GE} = 15V$ $I_C = 75A$	T _{vj} =25°C	-	1.70	2.15	
Collector-Emitter		1	T _{vj} =25°C	-	1.50	1.95	
saturation voltage	V _{CE(sat)}		, Т _{vi} =125°С	-	1.85	-	V
	(chip)		, Т _{vi} =150°С	-	1.95	-	1
			T _{vi} =175°C	-	2.00	-	1
Internal Gate resistance	rg	-	.,	-	8	-	Ω
	3	$V_{\rm CC} = 600 V$	T _{vi} =25°C	-	0.18	-	
	$t_{d(on)}$	$I_{\rm C} = 75 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	T _{vj} =125°C	-	0.21	-	-
		V _{GE} = +15/-15 V	T _{vj} =150°C	-	0.21	-	
		$R_{\rm G} = 5.1 \Omega$	T _{vi} =175°C	-	0.22	-	1
		$V_{\rm CC} = 600 V$	T _{vi} =25°C	-	0.04	-	-
		$I_{\rm C} = 75 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	τ _{vi} =125°C	-	0.05	-	-
	t _r	V _{GE} = +15/-15 V	τ _{vj} =150°C	-	0.05	-	
		$R_{\rm G} = 5.1 \Omega$., Τ _{vi} =175°C	-	0.05	-	1
Switching time (*1)		$V_{\rm CC} = 600 V$	T _{vi} =25°C	-	0.25	-	μs
		$I_{\rm C} = 75 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	τ _{vi} =125°C	-	0.28	-	1
	t _{d(off)}	V _{GE} = +15/-15 V	τ _{vj} =150°C	-	0.29	-	-
		$R_{\rm G} = 5.1 \Omega$., Τ _{vj} =175°C	-	0.29	-	-
		$V_{\rm CC} = 600 V$	T _{vi} =25°C	-	0.12	-	-
		$I_{\rm C} = 75 {\rm A} {\rm L}_{\rm s} = 30 {\rm nH}$	τ _{vi} =125°C	-	0.18	-	ł
	t _f	V _{GE} = +15/-15 V	τ _{vj} =150°C	-	0.20	-	ł
		$R_{\rm G} = 5.1 \Omega$	τ _{vi} =175°C	-	0.21	-	1
Reverse current	I _{RRM}	$V_{\rm R} = 1200 V$	<u> </u>	-	-	50	μA
	V _F (terminal)	$I_{\rm F} = 35A$	T _{vj} =25°C	-	2.00	2.45	P 5
Forward voltage		$I_{\rm F} = 35A$	T _{vj} =25°C	-	1.80	2.25	-
	V _F		T _{vj} =125°C	-	1.85	-	v
	(chip)		$T_{vj} = 150^{\circ}C$	-	1.80	-	+
			T _{vj} =175°C	-	1.75	-	ł
Reverse current	I _{RRM}	V _R = 1600V	· vj C C	-	-	50	μA
		$I_{\rm F} = 100{\rm A}$	terminal	-	1.30	1.80	
Forward voltage	V _{FM}	1	chip	-	1.05	1.50	V
		<i>T</i> = 25°C	P	-	5000	-	
Resistance	R	T = 23 C $T = 100^{\circ}\text{C}$		465	495	520	Ω
ResistanceRB valueB		$T = \frac{100 \text{ C}}{7}$		3305	3375	3450	ĸ

(*1) Turn on time $(t_{on}) = t_{d(on)} + t_r$, Turn off time $(t_{off}) = t_{d(off)} + t_f$



NOTICE:

The external gate resistance (R_G) shown above is one of our recommended value for the purpose of minimum switching loss. However the optimum R_G depends on circuit configuration and/or environment. We recommend that the R_G has to be carefully chosen based on consideration if IGBT module matches design criteria, for example, switching loss, EMC/EMI, spike voltage, surge current and no unexpected oscillation and so on.

□Thermal resistance characteristics

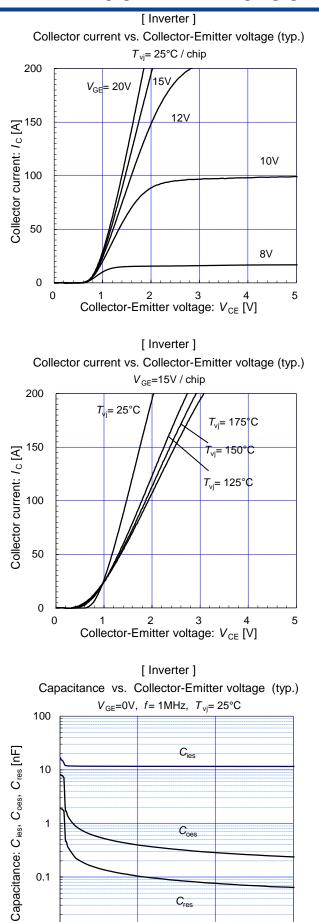
Items	Symbols	Conditions	Characteristics			Units
items	Symbols	Conditions	min.	typ.	max.	Units
		Inverter IGBT	-	-	0.34	
		Inverter FWD	-	-	0.45	
Thermal resistance (1device)	R _{th(j-c)}	Brake IGBT	-	-	0.45	°C/W
		Brake FWD	-	-	0.86	
		Converter Diode	-	-	0.47	
Contact thermal resistance	R	with 1 W/(m·K) thermal grease		0.05		
(1 IGBT+1 FWD) (*1)	$R_{ m th(c-f)}$		-	0.05	-	

(*1) This is the value which is defined mounting on the additional cooling fin with thermal grease.

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Collector - Emitter voltage: V_{CE} [V]

20

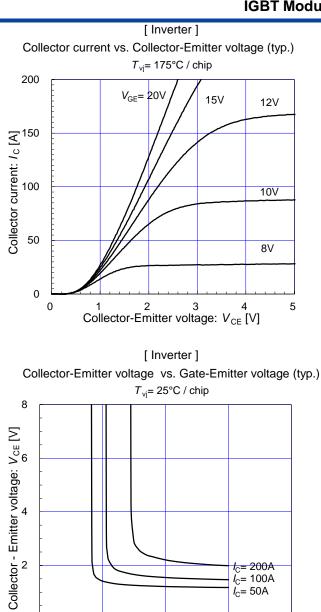
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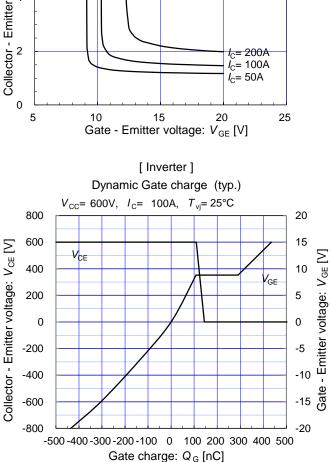
1

0.1

0.01

0





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30

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10

 $I_{\rm C} = 100 {\rm A}$

1

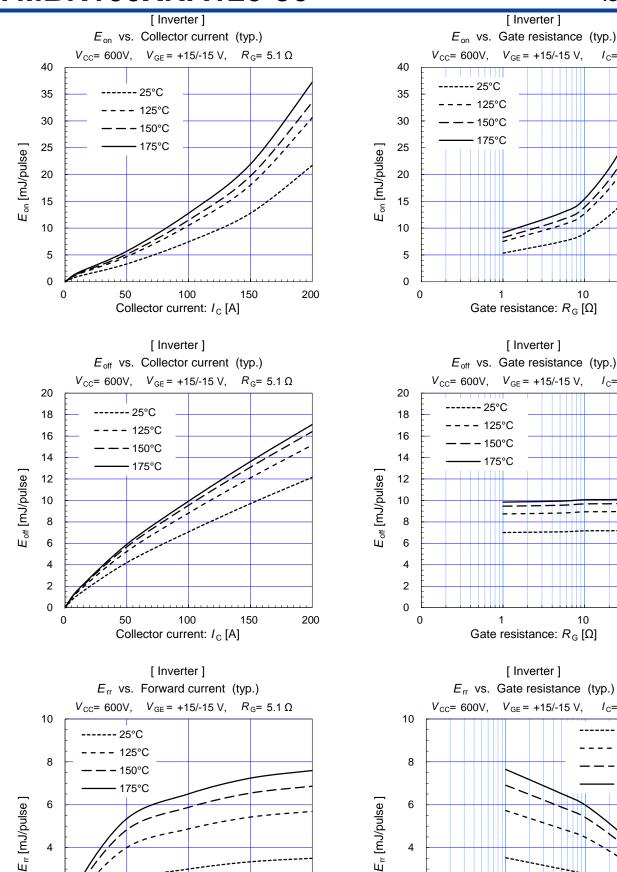
[Inverter]

[Inverter]

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100

 $I_{\rm C} = 100 {\rm A}$



2

0

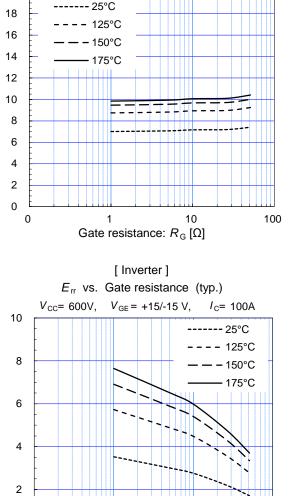
0

50

100

Forward current: I_F [A]

150



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100

200

0

0

1

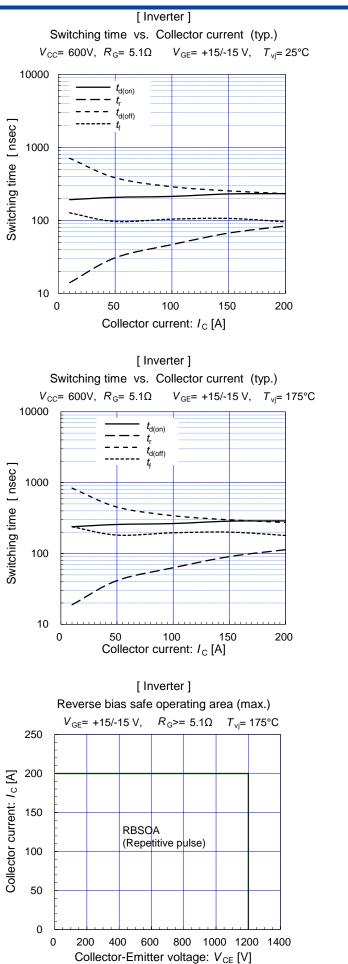
Gate resistance: $R_{\rm G}$ [Ω]

10

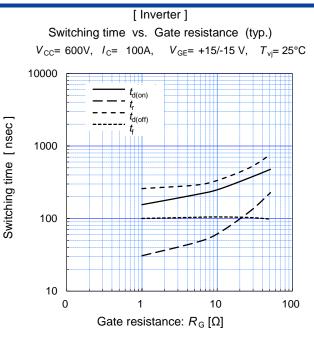
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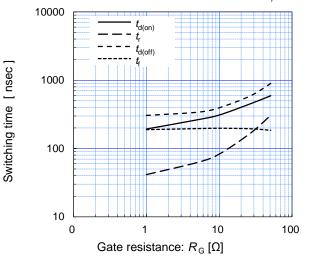


(Main terminals)





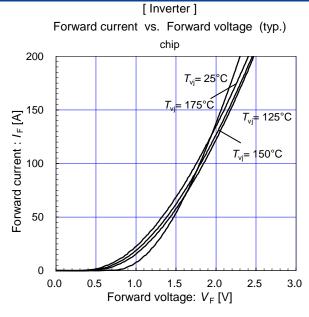


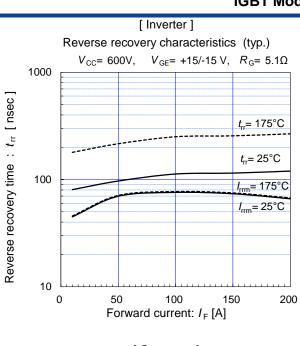


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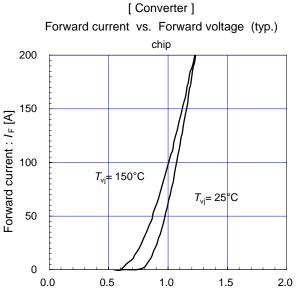
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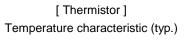
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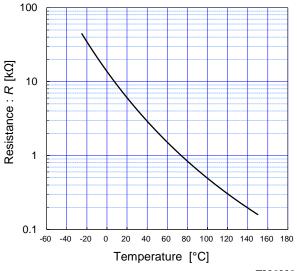


Reverse recovery current : I rm [A]





Forward voltage: V_F [V]



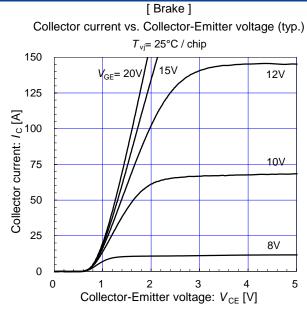
Transient thermal resistance (max.) 1 Thermal resistance : Rth(i-c) [°C/W] Conv. Diode IGBT[Brake] WD[Inverte IGBT[Inverter 0.1 0.002 0.030 r_n IGBT 0.0365 0.0925 0.1306 0.0804 FWD 0.0483 0.1224 0.1729 [°C/W] 0.1065 B-IGBT 0.0483 0.1224 0.1729 0.1065 Conv 0.1806 0.01 0.001 0.01 0.1 1 Pulse width: Pw [sec]

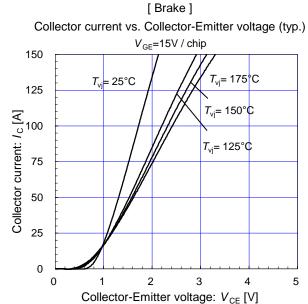
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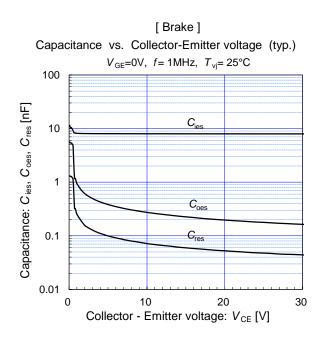
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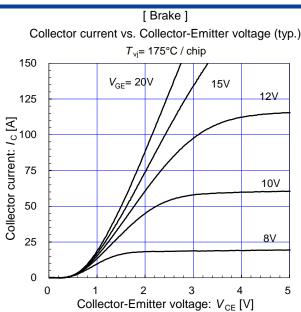
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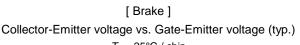
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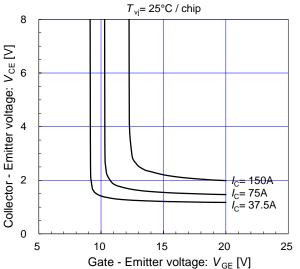


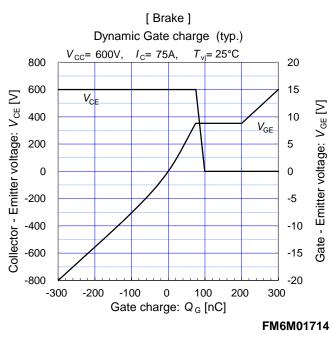












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